查询BTA16 BW供应商

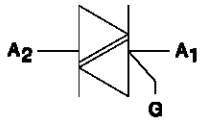
SGS-THOMSON MICROELECTRONICS

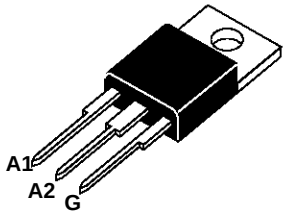
BTA16 BW/CW
BTB16 BW/CW

SNUBBERLESS TRIACS

FEATURES

- HIGH COMMUTATION : (dI/dt)c > 14A/ms without snubber
- HIGH SURGE CURRENT : I_{TSM} = 160A
- V_{DRM} UP TO 800V
- BTA Family : INSULATING VOLTAGE = 2500$V_{(RMS)}$ (UL RECOGNIZED : E81734)





TO220AB
(Plastic)

DESCRIPTION

The BTA/BTB16 BW/CW triac family are high performance glass passivated chips technology.
The SNUBBERLESS™ concept offer suppression of RC network and it is suitable for application such as phase control and static switching on inductive or resistive load.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (360° conduction angle)	BTA	Tc = 80 °C	16	A
		BTB	Tc = 90 °C		
I_{TSM}	Non repetitive surge peak on-state current (Tj initial = 25°C)		tp = 8.3 ms	170	A
			tp = 10 ms	160	
I^2t	I^2t value		tp = 10 ms	128	A^2s
dI/dt	Critical rate of rise of on-state current Gate supply : I_G = 500mA di_G/dt = 1A/µs		Repetitive F = 50 Hz	20	A/µs
			Non Repetitive	100	
Tstg Tj	Storage and operating junction temperature range			- 40 to + 150 - 40 to + 125	°C °C
Tl	Maximum lead temperature for soldering during 10 s at 4.5 mm from case			260	°C

Symbol	Parameter	BTA / BTB16-... BW/CW				Unit
		400	600	700	800	
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Tj = 125 °C	400	600	700	800	V

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
Rth (j-a)	Junction to ambient		60	°C/W
Rth (j-c) DC	Junction to case for DC	BTA	3.1	°C/W
		BTB	2.3	
Rth (j-c) AC	Junction to case for 360° conduction angle (F= 50 Hz)	BTA	2.3	°C/W
		BTB	1.75	

GATE CHARACTERISTICS (maximum values)

$P_{G\ (AV)}$ = 1W P_{GM} = 10W (tp = 20 µs) I_{GM} = 4A (tp = 20 µs) V_{GM} = 16V (tp = 20 µs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrant		Suffix		Unit
					BW	CW	
I_{GT}	V_D=12V (DC) R_L=33Ω	Tj=25°C	I-II-III	MIN	2	1	mA
				MAX	50	35	
V_{GT}	V_D=12V (DC) R_L=33Ω	Tj=25°C	I-II-III	MAX	1.5		V
V_{GD}	V_D=V_{DRM} R_L=3.3kΩ	Tj=125°C	I-II-III	MIN	0.2		V
tgt	V_D=V_{DRM} I_G = 500mA dI_G/dt = 3A/µs	Tj=25°C	I-II-III	TYP	2		µs
I_L	I_G=1.2 I_{GT}	Tj=25°C	I-III	TYP	40	-	mA
			II	TYP	80	-	
			I-III	MAX	-	50	
			II	MAX	-	80	
I_H *	I_T= 500mA gate open	Tj=25°C		MAX	50	35	mA
V_{TM} *	I_{TM}= 22.5A tp= 380µs	Tj=25°C		MAX	1.60		V
I_{DRM} I_{RRM}	V_{DRM} Rated V_{RRM} Rated	Tj=25°C		MAX	0.01		mA
		Tj=125°C		MAX	2		
dV/dt *	Linear slope up to V_D=67%V_{DRM} gate open	Tj=125°C		MIN	500	250	V/µs
				TYP	750	500	
(dI/dt)c *	Without snubber	Tj=125°C		MIN	14	8.5	A/ms
				TYP	28	17	

* For either polarity of electrode A2 voltage with reference to electrode A1.

ORDERING INFORMATION

Package	$I_{T(RMS)}$	V_{DRM} / V_{RRM}	Sensitivity Specification	
	A	V	BW	CW
BTA (Insulated)	16	400	X	X
		600	X	X
		700	X	X
		800	X	X
BTB (Uninsulated)		400	X	X
		600	X	X
		700	X	X
		800	X	X

Fig.1 : Maximum RMS power dissipation versus RMS on-state current (F=50Hz).
(Curves are cut off by (dI/dt)c limitation)

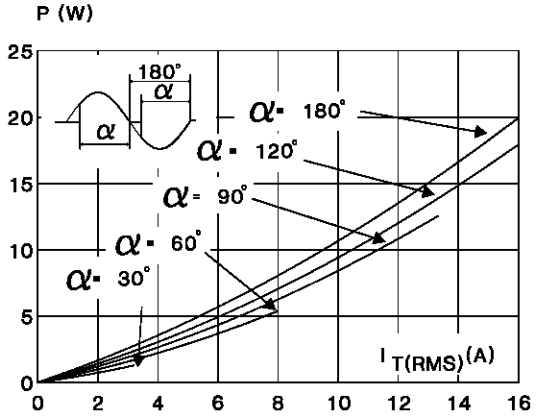


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (BTA).

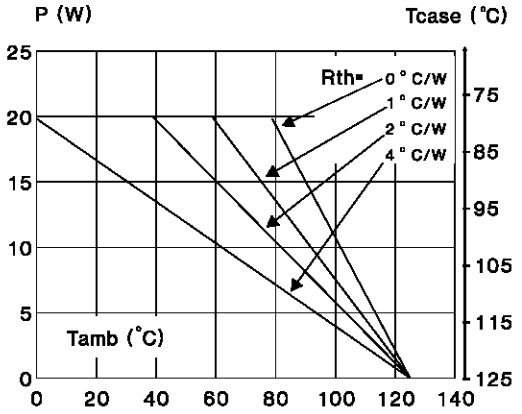


Fig.3 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (BTB).

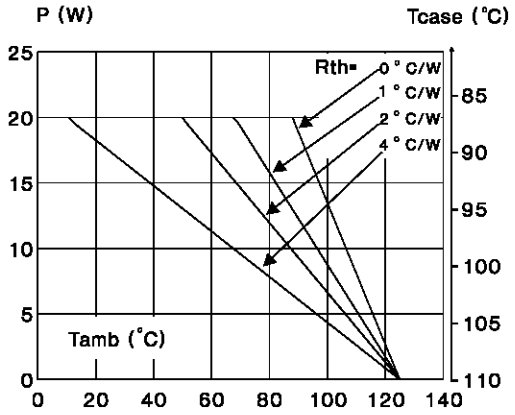


Fig.4 : RMS on-state current versus case temperature.

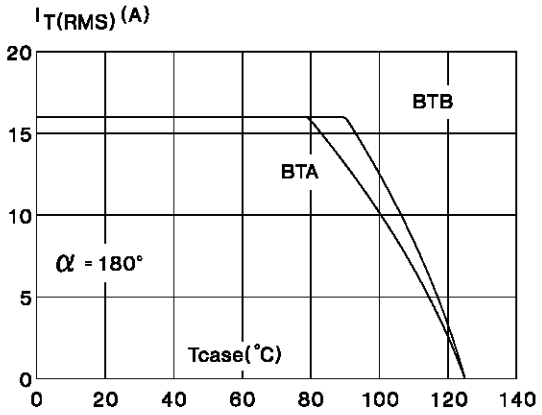


Fig.5 : Relative variation of thermal impedance versus pulse duration.

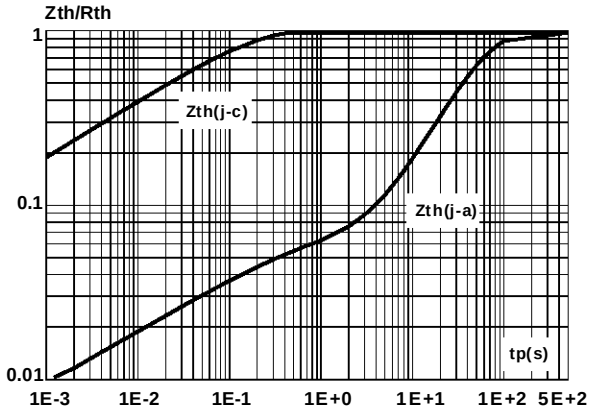


Fig.6 : Relative variation of gate trigger current and holding current versus junction temperature.

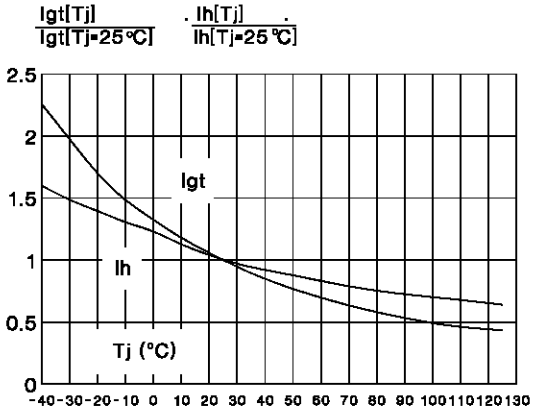


Fig.7 : Non Repetitive surge peak on-state current versus number of cycles.

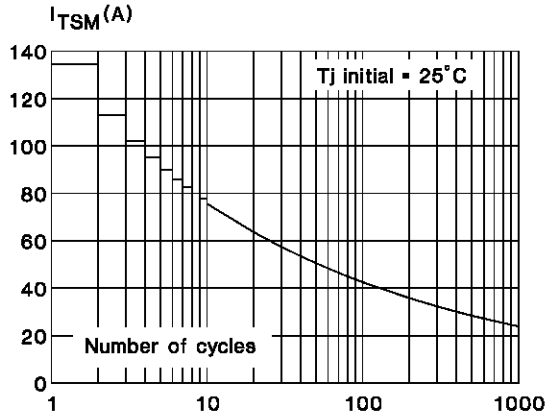


Fig.8 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : t ≤ 10ms, and corresponding value of I^2t.

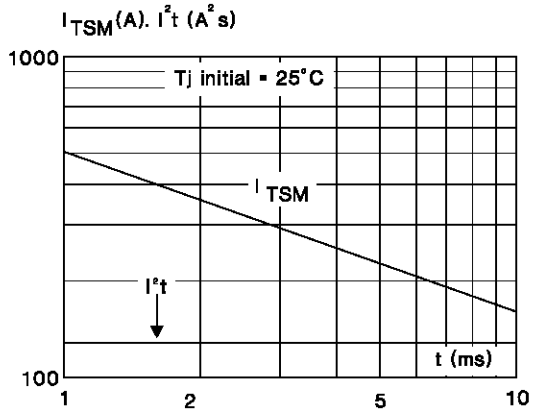
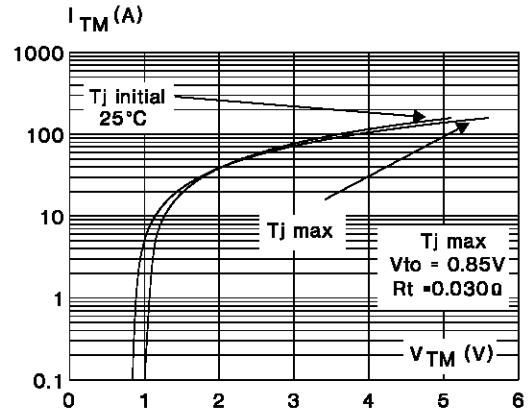
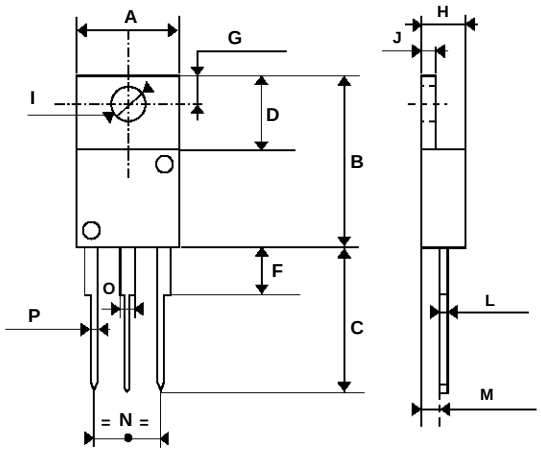


Fig.9 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO220AB Plastic



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	10.20	10.50	0.401	0.413
B	14.23	15.87	0.560	0.625
C	12.70	14.70	0.500	0.579
D	5.85	6.85	0.230	0.270
F		4.50		0.178
G	2.54	3.00	0.100	0.119
H	4.48	4.82	0.176	0.190
I	3.55	4.00	0.140	0.158
J	1.15	1.39	0.045	0.055
L	0.35	0.65	0.013	0.026
M	2.10	2.70	0.082	0.107
N	4.58	5.58	0.18	0.22
O	0.80	1.20	0.031	0.048
P	0.64	0.96	0.025	0.038

Cooling method : C
Marking : type number
Weight : 2.3 g
Recommended torque value : 0.8 m.N.
Maximum torque value : 1 m.N.

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